Kwik Kick curing agent is a low color, low viscosity modified cycloaliphatic amine intended for ambient or low temperature curing of liquid epoxy resins. The KK System gives high gloss, high strength films that are resistant to a variety of chemicals. These properties make it ideal for use in sports equipment, floorings, maintenance coatings, tank linings, and secondary containment linings. It’s very low color and good color stability and fast set times make it appropriate for numerous production applications.

Section 2: Advantages

- Very low color and good color stability
- Good chemical resistance
- High gloss
- Good resistance to amine blush
- Low viscosity
- Fast production times

Section 3: Applications

- High-solids coatings
- Self-leveling and pebble finish flooring
- Chemically resistant tank linings
- Sports equipment

Section 4: Handling Precautions

Refer to the Safety Data Sheet

Section 5: Storage Life

At least 12 months from the date of manufacture in the original sealed container at ambient temperature. Store away from heat and excessive humidity in tightly closed containers.
Section 6: Typical Properties

- Appearance: Clear Liquid
- Color (Gardner): 1
- Viscosity @ 77 °F (cP): 1200 mixed
- Amine Value Hardener (mg KOH/g): 360
- EEW Resin: 180
- Specific Gravity @ 77 °F: 1.2
- Density @ 77 °F (lb/gal): 8.7 mixed
- Flash Point (CC) Hardener (°F): 205
- Flash Point Resin: NA
- Recommended Use Level: 45phr weight or 50phr volume

Section 7: Typical Handling Properties

- Mixed Viscosity @ 77 °F (cP): 1200
- Gel Time (150g mix @ 77 °F) (min): 18
- Thin Film Set Time:
  - @ 77 °F (hr): 1.5
  - @ 50 °F (hr): 4
- Peak Exotherm (150g mix @ 77 °F) (°F): 184
- Peak Exotherm Time (min): 24

Section 8: Typical Performance

- (7 day cure @ 77 °F)
- Heat Deflection Temperature (°F): 125
- Tensile Strength (psi): 11,500
- Tensile Modulus: 488,000
- Tensile Elongation (%): 3.4
- Flexural Strength (psi): 16,500
- Flexural Modulus: 550,000
- Hardness (Shore D): 84
- Compression Yield: 17,000
- Mar Resistance (kg): 1.20

Section 9: Typical Cure Schedules

- 2–7 days at ambient temperature